SCES396A-JULY 2002-REVISED JUNE 2005

FEATURES

- Member of the Texas Instruments Widebus™
 Family
- DOC[™] Circuitry Dynamically Changes Output Impedance, Resulting in Noise Reduction Without Speed Degradation
- Dynamic Drive Capability Is Equivalent to Standard Outputs With I $_{\rm OH}$ and I $_{\rm OL}$ of \pm 24 mA at 2.5-V V $_{\rm CC}$
- Control Inputs V_{IH}/V_{IL} Levels Are Referenced to V_{CCA} Voltage
- If Either V_{CC} Input Is at GND, Both Ports Are in the High-Impedance State
- Overvoltage-Tolerant Inputs/Outputs Allow Mixed-Voltage-Mode Data Communications

- I_{off} Supports Partial-Power-Down Mode Operation
- Fully Configurable Dual-Rail Design Allows Each Port to Operate Over the Full 1.4-V to 3.6-V Power-Supply Range
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 100 mA Per JESD 78. Class II
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

DESCRIPTION/ORDERING INFORMATION

This 16-bit (dual-octal) noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.4 V to 3.6 V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.4 V to 3.6 V. This allows for universal low-voltage bidirectional translation between any of the 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

The SN74AVCAH164245 is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the outputs so the buses are effectively isolated.

The SN74AVCAH164245 is designed so that the control pins (1DIR, 2DIR, $1\overline{OE}$, and $2\overline{OE}$) are supplied by V_{CCA} .

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CCA} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down. If either V_{CC} input is at GND, then both ports are in the high-impedance state.

ORDERING INFORMATION

| T _A | PACKA | GE ⁽¹⁾ | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|----------------|-------------|-------------------|-----------------------|------------------|
| | TSSOP - DGG | Tape and reel | SN74AVCAH164245GR | AVCAH164245 |
| -40°C to 85°C | TVSOP - DGV | Tape and reel | SN74AVCAH164245VR | WAH4245 |
| | VFBGA – GQL | Tape and reel | SN74AVCAH164245KR | WAH4245 |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



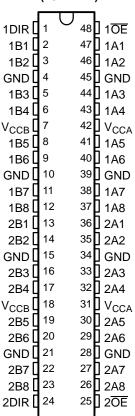
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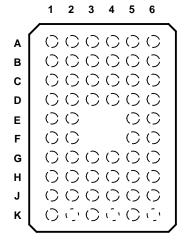


TERMINAL ASSIGNMENTS

DGG OR DGV PACKAGE (TOP VIEW)



GQL PACKAGE (TOP VIEW)



TERMINAL ASSIGNMENTS(1)

| | 1 | 2 | 3 | 4 | 5 | 6 |
|---|------|-----|------------------|------------------|-----|-----------------|
| Α | 1DIR | NC | NC | NC | NC | 1 OE |
| В | 1B2 | 1B1 | GND | GND | 1A1 | 1A2 |
| С | 1B4 | 1B3 | V_{CCB} | V_{CCA} | 1A3 | 1A4 |
| D | 1B6 | 1B5 | GND | GND | 1A5 | 1A6 |
| E | 1B8 | 1B7 | | | 1A7 | 1A8 |
| F | 2B1 | 2B2 | | | 2A2 | 2A1 |
| G | 2B3 | 2B4 | GND | GND | 2A4 | 2A3 |
| Н | 2B5 | 2B6 | V _{CCB} | V _{CCA} | 2A6 | 2A5 |
| J | 2B7 | 2B8 | GND | GND | 2A8 | 2A7 |
| K | 2DIR | NC | NC | NC | NC | 2 OE |

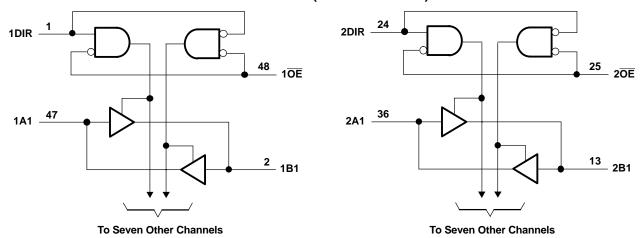
(1) NC - No internal connection

FUNCTION TABLE (EACH 8-BIT SECTION)

| INP | UTS | OPERATION |
|-----|-----|-----------------|
| ŌĒ | DIR | OPERATION |
| L | L | B data to A bus |
| L | Н | A data to B bus |
| Н | X | Isolation |



LOGIC DIAGRAM (POSITIVE LOGIC)



Pin numbers shown are for the DGG and DGV packages.

Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|--------------------------------------|---|--------------------|------|------------------------|------|
| V _{CCA} V _{CCB} | Supply voltage range | | -0.5 | 4.6 | V |
| | | I/O ports (A port) | -0.5 | 4.6 | |
| V_{I} | Input voltage range (2) | I/O ports (B port) | -0.5 | 4.6 | V |
| | | Control inputs | -0.5 | 4.6 | |
| V | Voltage range applied to any output in the high-impedance or | A port | -0.5 | 4.6 | V |
| V _O | power-off state ⁽²⁾ | B port | -0.5 | 4.6 | V |
| V | Valtage range applied to any output in the high or law state (2)(3) | A port | -0.5 | V _{CCA} + 0.5 | V |
| Vo | Voltage range applied to any output in the high or low state (2)(3) | B port | -0.5 | V _{CCB} + 0.5 | V |
| I _{IK} | Input clamp current | V _I < 0 | | -50 | mA |
| l _{ok} | Output clamp current | V _O < 0 | | -50 | mA |
| lo | Continuous output current | | | ±50 | mA |
| | Continuous current through V _{CCA} , V _{CCB} , or GND | | | ±100 | mA |
| | | DGG package | | 70 | |
| θ_{JA} | Package thermal impedance ⁽⁴⁾ | DGV package | | 58 | °C/W |
| | | GQL package | | 28 | |
| T _{stg} | Storage temperature range | · | -65 | 150 | °C |

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

⁽²⁾ The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

⁽³⁾ The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current rating is observed.

⁽⁴⁾ The package thermal impedance is calculated in accordance with JESD 51-7.



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Recommended Operating Conditions (1)(2)(3)

| | | | V _{CCI} | V _{cco} | MIN | MAX | UNIT |
|------------------|------------------------------|--|------------------|------------------|--------------------------------|-------------------------|------------|
| V_{CCA} | Supply voltage | | | | 1.4 | 3.6 | V |
| V _{CCB} | Supply voltage | | | | 1.4 | 3.6 | V |
| | | | 1.4 V to 1.95 V | | V _{CCI} × 0.65 | | |
| V_{IH} | High-level input voltage | Data inputs | 1.95 V to 2.7 V | | 1.7 | | V |
| | | | 2.7 V to 3.6 V | | 2 | | |
| | | | 1.4 V to 1.95 V | | | V _{CCI} × 0.35 | |
| V_{IL} | Low-level input voltage | Data inputs | 1.95 V to 2.7 V | | | 0.7 | V |
| | | | 2.7 V to 3.6 V | | | 0.8 | |
| | | _ | 1.4 V to 1.95 V | | V _{CCA} × 0.65 | | |
| V_{IH} | High-level input voltage | Control inputs (referenced to V _{CCA}) | 1.95 V to 2.7 V | | 1.7 | | V |
| | | (referenced to VCCA) | 2.7 V to 3.6 V | | 2 | | |
| | | _ | 1.4 V to 1.95 V | | | V _{CCA} × 0.35 | |
| V_{IL} | Low-level input voltage | Control inputs (referenced to V _{CCA}) | 1.95 V to 2.7 V | | | 0.7 | V |
| | | (referenced to VCCA) | 2.7 V to 3.6 V | | | 8.0 | |
| V_{I} | Input voltage | | | | 0 | 3.6 | V |
| \/ | Output voltage | Active state | | | 0 | V_{CCO} | V |
| V _O | Output voltage | 3-state | | | 0 | 3.6 | V |
| | | | | 1.4 V to 1.6 V | | -2 | |
| | Lligh lovel output ourrent | | | 1.65 V to 1.95 V | | -4 | ∞ Λ |
| I _{OH} | High-level output current | | | 2.3 V to 2.7 V | | 8– | mA |
| | | | | 3 V to 3.6 V | | -12 | |
| | | | | 1.4 V to 1.6 V | | 2 | |
| | Low lovel output ourrent | | | 1.65 V to 1.95 V | | 4 | mΛ |
| l _{OL} | Low-level output current | | | 2.3 V to 2.7 V | | 8 | mA |
| | | | | 3 V to 3.6 V | | 12 | |
| Δt/Δν | Input transition rise or fal | l rate | | | | 5 | ns/V |
| T _A | Operating free-air temper | rature | | | -40 | 85 | °C |

 V_{CCI} is the V_{CC} associated with the data input port. V_{CCO} is the V_{CC} associated with the output port. All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.



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Electrical Characteristics (1)(2)

over recommended operating free-air temperature range (unless otherwise noted)

| P | ARAMETER | TEST CON | DITIONS | V _{CCA} | V _{CCB} | MIN | TYP(3) | MAX | UNIT |
|---------------------------------|----------------|---|----------------------|------------------|------------------|--------------------------|--------|-------|------|
| | | $I_{OH} = -100 \mu A$, | $V_I = V_{IH}$ | 1.4 V to 3.6 V | 1.4 V to 3.6 V | V _{CCO} – 0.2 V | | | |
| | | $I_{OH} = -2 \text{ mA},$ | $V_I = V_{IH}$ | 1.4 V | 1.4 V | 1.05 | | | |
| V_{OH} | | $I_{OH} = -4 \text{ mA},$ | $V_I = V_{IH}$ | 1.65 V | 1.65 V | 1.2 | | | V |
| | | $I_{OH} = -8 \text{ mA},$ | $V_{I} = V_{IH}$ | 2.3 V | 2.3 V | 1.75 | | | |
| | | $I_{OH} = -12 \text{ mA},$ | $V_I = V_{IH}$ | 3 V | 3 V | 2.3 | | | |
| | | $I_{OH} = 100 \mu A$, | $V_I = V_{IL}$ | 1.4 V to 3.6 V | 1.4 V to 3.6 V | | | 0.2 | |
| | | $I_{OH} = 2 \text{ mA},$ | $V_I = V_{IL}$ | 1.4 V | 1.4 V | | | 0.35 | |
| V_{OL} | | $I_{OH} = 4 \text{ mA},$ | $V_I = V_{IL}$ | 1.65 V | 1.65 V | | | 0.45 | V |
| | | $I_{OH} = 8 \text{ mA},$ | $V_I = V_{IL}$ | 2.3 V | 2.3 V | | | 0.55 | |
| | | $I_{OH} = 12 \text{ mA},$ | $V_I = V_{IL}$ | 3 V | 3 V | | | 0.7 | |
| I_{\parallel} | Control inputs | $V_I = V_{CCA}$ or GND | | 1.4 V to 3.6 V | 3.6 V | | | ±2.5 | μA |
| | | V _I = 0.49 V | | 1.4 V | 1.4 V | | 11 | | |
| . (4) | 1 | V _I = 0.57 V | | 1.65 V | 1.65 V | | 30 | | |
| I _{BHL} ⁽⁴⁾ | | $V_1 = 0.7 \ V$ | | 2.3 V | 2.3 V | 45 | | | μA |
| | | $V_1 = 0.8 \text{ V}$ | | 3 V | 3 V | 75 | | | |
| | | V _I = 0.91 V | | 1.4 V | 1.4 V | | -11 | | |
| . (5 |) | V _I = 1.07 V | | 1.65 V | 1.65 V | | -30 | | |
| I _{BHH} ⁽⁵ | , | V _I = 1.7 V | | 2.3 V | 2.3 V | -45 | | | μA |
| | | V _I = 2 V | | 3 V | 3 V | -75 | | | |
| | | | | 1.6 V | 1.6 V | 100 | | | |
| . (| 6) | V 0 to V | | 1.95 V | 1.95 V | 200 | | | |
| I _{BHLO} (| 5 , | $V_I = 0$ to V_{CC} | | 2.7 V | 2.7 V | 300 | | | μΑ |
| | | | | 3.6 V | 3.6 V | 525 | | | |
| | | | | 1.6 V | 1.6 V | -100 | | | |
| | (7) | $V_{I} = 0$ to V_{CC} | | 1.95 V | 1.95 V | -200 | | | |
| I _{BHHO} | (*) | $v_1 = 0 \text{ to } v_{CC}$ | | 2.7 V | 2.7 V | -300 | | | μΑ |
| | | | | 3.6 V | 3.6 V | -525 | | | |
| | A port | $V_1 \text{ or } V_0 = 0 \text{ to } 3.6 \text{ V}$ | | 0 V | 0 to 3.6 V | | | ±10 | μΑ |
| I _{off} | B port | v ₁ or v ₀ = 0 to 3.6 V | | 0 to 3.6 V | 0 V | | | ±10 | μA |
| | A or B ports | ., ., | OE = V _{IH} | 3.6 V | 3.6 V | | | ±12.5 | |
| $I_{OZ}^{(8)}$ | B port | $V_O = V_{CCO}$ or GND, $V_I = V_{CCI}$ or GND | OE = don't care | 0 V | 3.6 V | | | ±12.5 | μΑ |
| | A port | - 1 100 0. 0.10 | OE = dont care | 3.6 V | 0 V | | | ±12.5 | |

- V_{CCO} is the V_{CC} associated with the output port. V_{CCI} is the V_{CC} associated with the input port.

- An external driver must source at least $I_{\mbox{\footnotesize{BHLO}}}$ to switch this node from low to high.
- An external driver must sink at least I_{BHHO} to switch this node from high to low.
- For I/O ports, the parameter I_{OZ} includes the input leakage current.

All typical values are at $T_A = 25$ °C. The bus-hold circuit can sink at least the minimum low sustaining current at V_{IL} max. I_{BHL} should be measured after lowering V_{IN} to GND and then raising it to V_{IL} max.

The bus-hold circuit can source at least the minimum high sustaining current at V_{IH} min. I_{BHH} should be measured after raising V_{IN} to V_{CC} and then lowering it to V_{IH} min.



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Electrical Characteristics(1)(continued)

over recommended operating free-air temperature range (unless otherwise noted)

| PA | RAMETER | TEST COM | IDITIONS | V _{CCA} | V _{CCB} | MIN TYP(2) | MAX | UNIT |
|------------------|----------------|------------------------------|-------------|------------------|------------------|------------|-----|------|
| | | | | 1.6 V | 1.6 V | | 20 | |
| | | | | 1.95 V | 1.95 V | | 20 | |
| | | V V ar CND | 1 0 | 2.7 V | 2.7 V | | 30 | ^ |
| I _{CCA} | | $V_I = V_{CCI}$ or GND, | $I_{O} = 0$ | 0 V | 3.6 V | | -40 | μA |
| | | | | 3.6 V | 0 V | | 40 | |
| | | | | 3.6 V | 3.6 V | | 40 | |
| | | | | 1.6 V | 1.6 V | | 20 | |
| | | | | 1.95 V | 1.95 V | | 20 | |
| | | V V as CND | 1 0 | 2.7 V | 2.7 V | | 30 | |
| I _{CCB} | | $V_I = V_{CCI}$ or GND, | $I_{O} = 0$ | 0 V | 3.6 V | | 40 | μA |
| | | | | 3.6 V | 0 V | | -40 | |
| | | | | 3.6 V | 3.6 V | | 40 | |
| C _i | Control inputs | $V_I = 3.3 \text{ V or GND}$ | | 3.3 V | 3.3 V | 4 | | pF |
| C _{io} | A or B ports | $V_O = 3.3 \text{ V or GND}$ | | 3.3 V | 3.3 V | 5 | | pF |

 V_{CCI} is the V_{CC} associated with the input port. All typical values are at T_A = 25°C.

Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 1.5 \text{ V} \pm 0.1 \text{ V}$ (see Figure 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.2 | | V _{CCB} = ± 0.3 | | UNIT |
|------------------|-----------------|----------------|--------------------------|-----|-----------------------------|------|-----------------------------|------|-----------------------------|------|------|
| | (INPOT) | (001701) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| 4 | A | В | 1.7 | 6.7 | 1.9 | 6.3 | 1.8 | 5.5 | 1.7 | 5.8 | |
| t _{pd} | В | A | 1.8 | 6.8 | 2.2 | 7.4 | 2.1 | 7.6 | 2.1 | 7.3 | ns |
| 4 | ŌĒ | A | 2.6 | 8.4 | 2.7 | 8.2 | 2.3 | 6.3 | 2.1 | 5.6 | 20 |
| t _{en} | OE | В | 2.7 | 8.6 | 3.2 | 10.2 | 3.2 | 10.8 | 3.2 | 10.7 | ns |
| | ŌĒ | Α | 2.1 | 7 | 2.5 | 7 | 1.7 | 5.3 | 2 | 6.1 | 20 |
| t _{dis} | OE . | В | 2.1 | 7.1 | 2.5 | 7.1 | 2.1 | 6.5 | 2.1 | 6.4 | ns |

Switching Characteristics

over recommended operating free-air temperature range, $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$ (see Figure 2)

| PARAMETER | FROM | TO (OUTPUT) | V _{CCB} = ± 0.7 | | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.2 | | V _{CCB} = ± 0.3 | | UNIT |
|------------------|---------|-------------|--------------------------|-----|--------------------------|-----|--------------------------|-----|--------------------------|-----|------|
| | (INPUT) | (OUTPUT) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| 4 | А | В | 1.7 | 6.4 | 1.8 | 6 | 1.7 | 4.7 | 1.6 | 4.3 | 20 |
| t _{pd} | В | A | 1.4 | 5.5 | 1.8 | 6 | 1.8 | 5.8 | 1.8 | 5.5 | ns |
| | ŌĒ | A | 2.5 | 8 | 2.7 | 7.8 | 2.2 | 5.8 | 2 | 5.1 | 20 |
| t _{en} | OE | В | 1.8 | 6.7 | 2.7 | 7.8 | 2.7 | 8.1 | 2.7 | 8.1 | ns |
| | ŌĒ | А | 2.1 | 6.4 | 2.5 | 6.4 | 1.5 | 4.5 | 1.8 | 5 | 20 |
| t _{dis} | OE | В | 2.1 | 6.6 | 2.5 | 6.4 | 2 | 5.5 | 2 | 5.5 | ns |

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Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 2.5 V \pm 0.2 V (see Figure 2)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CCB} = ± 0.1 | 1.5 V 1 V | V _{CCB} = ± 0.1 | | V _{CCB} = ± 0.2 | | V _{CCB} = ± 0.3 | | UNIT |
|------------------|-----------------|----------------|--------------------------|--------------|-----------------------------|-----|-----------------------------|-----|--------------------------|-----|------|
| | (INPOT) | (001701) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| 4 | Α | В | 1.6 | 6 | 1.8 | 5.6 | 1.5 | 4 | 1.4 | 3.4 | 20 |
| t _{pd} | В | Α | 1.3 | 4.6 | 1.7 | 4.4 | 1.5 | 4 | 1.4 | 3.7 | ns |
| + | ŌĒ | А | 2.6 | 7.4 | 2.7 | 7.2 | 2.2 | 5.3 | 2 | 4.5 | ns |
| t _{en} | OL | В | 1.2 | 4.1 | 2.2 | 5.1 | 2.2 | 5.3 | 2.2 | 5.3 | 110 |
| | ŌĒ | A | 2 | 5.7 | 2.3 | 5.7 | 1.4 | 3.7 | 1.6 | 4 | 20 |
| t _{dis} | OE . | В | 0.9 | 4.5 | 1.7 | 4.5 | 1.4 | 3.7 | 1.4 | 3.7 | ns |

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 3.3 V ± 0.3 V (see Figure 2)

| PARAMETER | FROM | FROM TO (INPUT) | | V _{CCB} = 1.5 V V _{CCB} = 1.8 V ± 0.15 V | | V _{CCB} = 2.5 V ± 0.2 V | | V _{CCB} = 3.3 V ± 0.3 V | | UNIT | |
|------------------|---------|-----------------|-----|--|-----|-------------------------------------|-----|-------------------------------------|-----|------|----|
| | (INFOT) | (001701) | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| | А | В | 1.5 | 5.9 | 1.7 | 5.4 | 1.5 | 3.7 | 1.4 | 3.1 | 20 |
| t _{pd} | В | Α | 1.3 | 4.5 | 1.6 | 3.8 | 1.5 | 3.3 | 1.4 | 3.1 | ns |
| | ŌĒ | Α | 2.5 | 7 | 2.6 | 6.9 | 2.1 | 5 | 1.9 | 4.1 | 20 |
| t _{en} | OE | В | 0.8 | 2.6 | 1.9 | 4 | 2 | 4.1 | 1.9 | 4.1 | ns |
| | ŌĒ | Α | 1.2 | 5.4 | 2.2 | 5.2 | 1.2 | 3.3 | 1.5 | 3.6 | |
| t _{dis} | OE | В | 1.2 | 5.4 | 1.7 | 4.4 | 1.5 | 3.6 | 1.5 | 3.6 | ns |

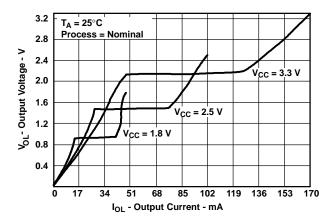
Operating Characteristics

 V_{CCA} and V_{CCB} = 3.3 V, T_{A} = 25°C

| | PARAMETER | | TEST (| CONDITIONS | TYP | UNIT |
|------------------|--|------------------|------------|-------------|-----|------|
| | Power dissipation capacitance per transceiver, | Outputs enabled | | | 14 | |
| _ | A-port input, B-port output | Outputs disabled | C - 0 | f = 10 MHz | 7 | рF |
| C _{pdA} | Power dissipation capacitance per transceiver, | Outputs enabled | $C_L = 0,$ | I = 10 WIHZ | 20 | рг |
| | B-port input, A-port output | Outputs disabled | | | 7 | |
| | Power dissipation capacitance per transceiver, | Outputs enabled | | | 14 | |
| _ | A-port input, B-port output | Outputs disabled | | f 10 MHz | 7 | _ |
| C _{pdB} | Power dissipation capacitance per transceiver, | Outputs enabled | $C_L = 0,$ | f = 10 MHz | 20 | pF |
| | B-port input, A-port output | Outputs disabled | | | 7 | |

Output Description

The DOCTM circuitry is implemented, which, during the transition, initially lowers the output impedance to effectively drive the load and, subsequently, raises the impedance to reduce noise. Figure 1 shows typical V_{OL} vs I_{OL} and V_{OH} vs I_{OH} curves to illustrate the output impedance and drive capability of the circuit. At the beginning of the signal transition, the DOC circuit provides a maximum dynamic drive that is equivalent to a high-drive standard-output device. For more information, refer to the TI application reports, *AVC Logic Family Technology and Applications*, literature number SCEA006, and *Dynamic Output Control (DOCTM) Circuitry Technology and Applications*, literature number SCEA009.



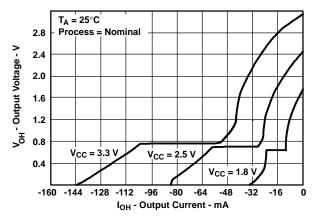
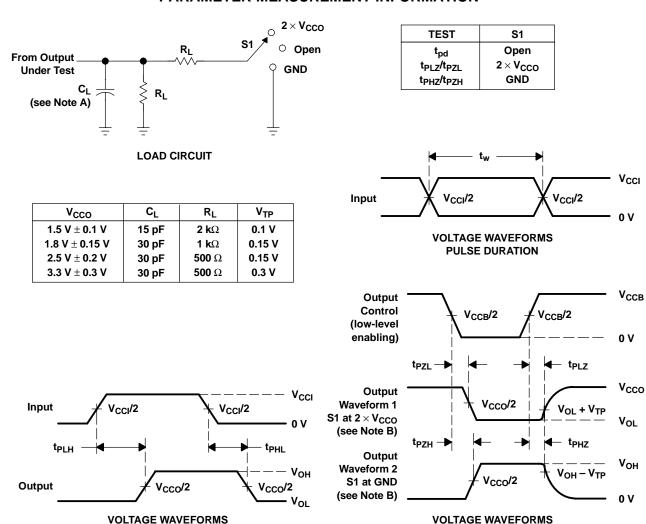


Figure 1. Output Voltage vs Output Current



PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.

ENABLE AND DISABLE TIMES

- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_0 = 50 Ω , $dv/dt \geq$ 1 V/ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en}.
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. V_{CCI} is the V_{CC} associated with the input port.
- I. V_{CCO} is the V_{CC} associated with the output port.

PROPAGATION DELAY TIMES

Figure 2. Load Circuit and Voltage Waveforms

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PACKAGING INFORMATION

| Orderable part number | Status | Material type | Package Pins | Package qty Carrier | RoHS | Lead finish/ | MSL rating/ | Op temp (°C) | Part marking |
|-----------------------|--------|---------------|------------------|-----------------------|------|---------------|--------------------|--------------|--------------|
| | (1) | (2) | | | (3) | Ball material | Peak reflow | | (6) |
| | | | | | | (4) | (5) | | |
| 74AVCAH164245VRG4 | Active | Production | TVSOP (DGV) 48 | 2000 LARGE T&R | - | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | WAH4245 |
| 74AVCAH164245VRG4.B | Active | Production | TVSOP (DGV) 48 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | WAH4245 |
| SN74AVCAH164245GR | Active | Production | TSSOP (DGG) 48 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | AVCAH164245 |
| SN74AVCAH164245GR.B | Active | Production | TSSOP (DGG) 48 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | AVCAH164245 |
| SN74AVCAH164245VR | Active | Production | TVSOP (DGV) 48 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | WAH4245 |
| SN74AVCAH164245VR.B | Active | Production | TVSOP (DGV) 48 | 2000 LARGE T&R | Yes | NIPDAU | Level-1-260C-UNLIM | -40 to 85 | WAH4245 |

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



PACKAGE OPTION ADDENDUM

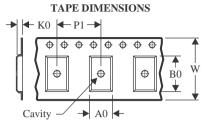
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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width |
|----|---|
| В0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

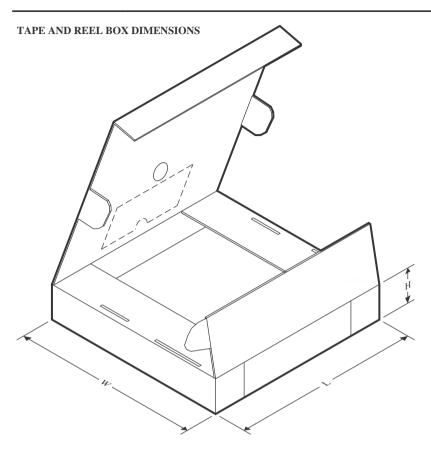
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| 74AVCAH164245VRG4 | TVSOP | DGV | 48 | 2000 | 330.0 | 16.4 | 7.1 | 10.2 | 1.6 | 12.0 | 16.0 | Q1 |
| SN74AVCAH164245GR | TSSOP | DGG | 48 | 2000 | 330.0 | 24.4 | 8.6 | 13.0 | 1.8 | 12.0 | 24.0 | Q1 |
| SN74AVCAH164245VR | TVSOP | DGV | 48 | 2000 | 330.0 | 16.4 | 7.1 | 10.2 | 1.6 | 12.0 | 16.0 | Q1 |

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*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| 74AVCAH164245VRG4 | TVSOP | DGV | 48 | 2000 | 353.0 | 353.0 | 32.0 |
| SN74AVCAH164245GR | TSSOP | DGG | 48 | 2000 | 356.0 | 356.0 | 45.0 |
| SN74AVCAH164245VR | TVSOP | DGV | 48 | 2000 | 353.0 | 353.0 | 32.0 |

DGV (R-PDSO-G**)

24 PINS SHOWN

PLASTIC SMALL-OUTLINE



NOTES: A. All linear dimensions are in millimeters.

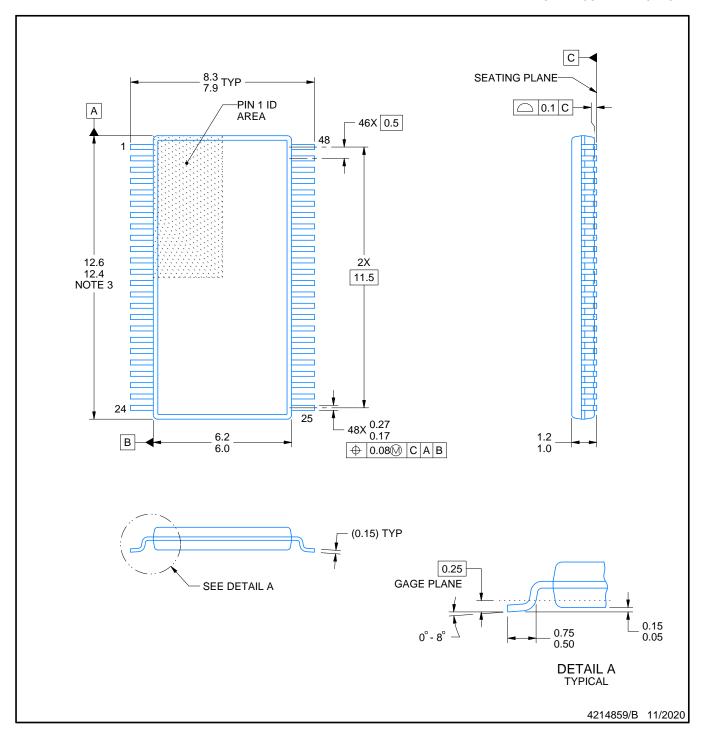
B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.

D. Falls within JEDEC: 24/48 Pins – MO-153 14/16/20/56 Pins – MO-194



SMALL OUTLINE PACKAGE



NOTES:

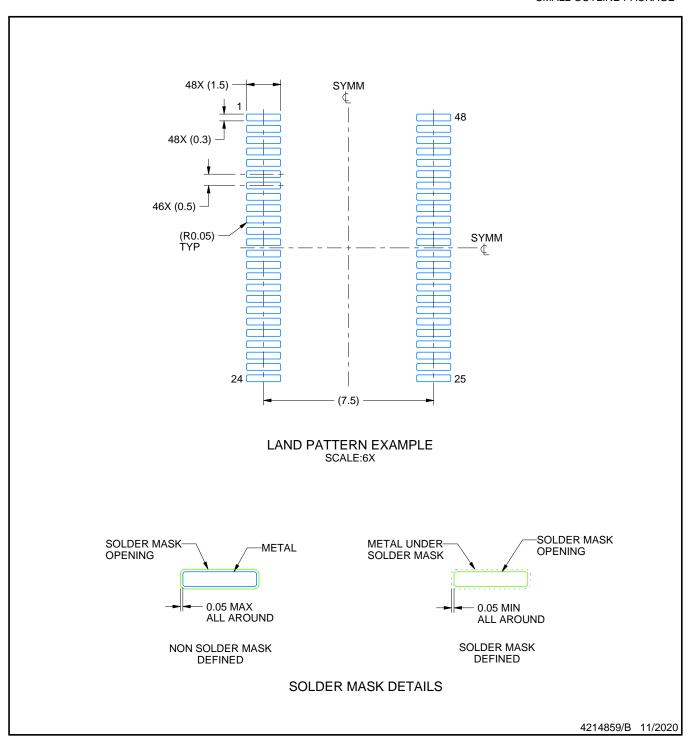
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
 4. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE

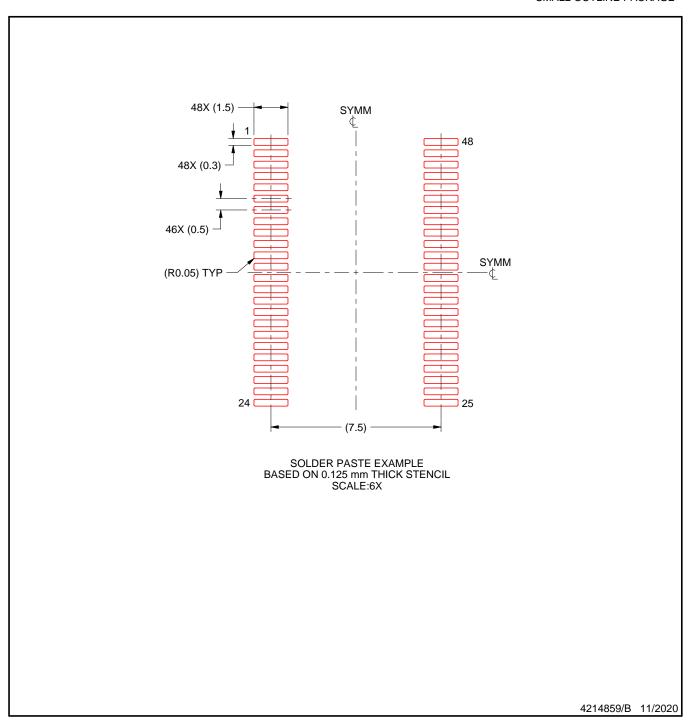


NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



DGG (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

48 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold protrusion not to exceed 0,15.

D. Falls within JEDEC MO-153

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